





FEATURES

- Weldable or threaded process fittings
- ±0.25% Accuracy
- ±1.0 Total Error Band
- Cable/connector option
- Low power option
- I²C or SPI Interface protocols

APPLICATIONS

- Level controls
- Tank level measurement
- Corrosive fluids and gas measurement systems
- Sealed systems
- Manifold pressure measurement
- Barometric pressure measurement
- Submersible depth monitoring

85BSD

Digital Output

SPECIFICATIONS

- Weldable or threaded process fittings
- Pressure/temperature read-out
- Digital output
- ASIC calibrated
- Absolute, gage
- Cable/connector option
- Low power option
- 13mm diaphragm diameter

The 85BSD is a small profile, media compatible, piezoresistive silicon pressure sensor packaged in a 316L stainless steel housing. This 14-bit digital output pressure sensor supports I²C and SPI interface protocols in either a 3.3 or 5.0Vdc supply voltage, and is designed to be weldable or threaded with process fittings. The sensing package utilizes silicone oil to transfer pressure from the 316L stainless steel diaphragm to the sensing element.

The 85BSD is designed for high performance, low pressure applications. A custom ASIC is used for temperature compensation, offset correction, and provides a digital output of $10\sim90\%$ or $5\sim95\%$.

For a similar sensor with O-ring mounting, refer to the 86BSD digital output pressure sensor



STANDARD RANGES

Range	psiG	psiA	Range	barG	barA
0 to 005	•		0 to .35	•	
0 to 015	•	•	0 to 001	•	•
0 to 030	•	•	0 to 002	•	•
0 to 050	•	•	0 to 005	•	•
0 to 100	•	•	0 to 007	•	•
0 to 150	•	•	0 to 010	•	•
0 to 200	•	•	0 to 014	•	•
0 to 300	•	•	0 to 020	•	•

Intermediate pressure ranges available, contact factory

PERFORMANCE SPECIFICATIONS

	666		0	
			Count Hex	1
	333		Count Hex	1
	399A		Count Hex	1
	3CCB		Count Hex	1
-0.25		0.25	%Span	2
-1		1	%Span	3
0.008			%Span	
-1.5		1.5	°C	4
	0.1		°C	
2.7	3.3	5.5	V	1
	3		mA	
50			ΜΩ	5
		2X	Rated	6
		3X	Rated	7
10			ΚΩ	
	±0.5		%Span/Year	
0		50	°C	
-20		+85	°C	
-40		+125	°C	8
-40		+125	°C	8
		14	Bits	
8		11	Bits	
		8.4	ms	9
10% to 90% or 59	% to 95%			
I ² C (ADDR, 0X36 I ² C (ADDR, 0x46)	H)			
	-1 0.008 -1.5 2.7 50 10 0 -20 -40 -40 8 10% to 90% or 56 12°C (ADDR, 0x28) 12°C (ADDR, 0x36) 12°C (ADDR, 0x46) SPI	-0.25 -1 0.008 -1.5 0.1 2.7 3.3 3 50 10 ±0.5 0 -20 -40 -40 -40 8 10% to 90% or 5% to 95% I²C (ADDR, 0x28H) I²C (ADDR, 0x36H) I²C (ADDR, 0x46H) SPI	-0.25 0.25 -1 1 0.008 -1.5 1.5 0.1 2.7 3.3 5.5 3 50 2X 3X 10 ±0.5 0 50 -20 +85 -40 +125 -40 +125 -40 +125 14 8 11 8 41 10% to 90% or 5% to 95% I²C (ADDR, 0x28H) I²C (ADDR, 0x36H) I²C (ADDR, 0x46H) SPI	-0.25

85BSD

Digital Output

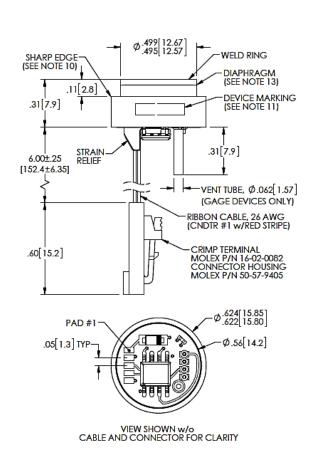


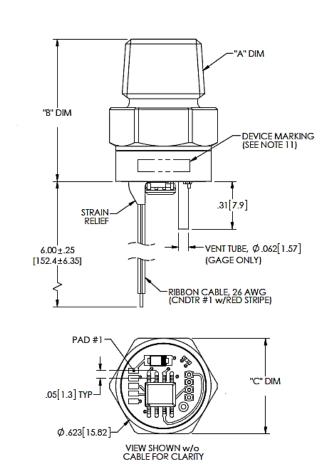
Notes

- Measured at vacuum for absolute(A), ambient for gage(G) and sealed gage(S). Output is not ratiometric to supply voltage.
- 2. Accuracy: combined linearity, hysteresis and repeatability.
- 3. Total Error Band: includes calibration errors and temperature effects over the compensated range. See Figure 3.
- 4. The deviation from a best fit straight line (BFSL) fitted to the output measured over the compensated temperature range. For errors beyond the compensated temperature range, See Figure 2.
- 5. Between case and sensing element.
- 6. 2X or 400psi, whichever is less. The maximum pressure that can be applied to a transducer without changing the transducer's performance or accuracy.
- 7. 3X or 600psi, whichever is less. The maximum pressure that can be applied to a transducer without rupture of either the sensing element or transducer.
- 8. Maximum temperature range for product with standard cable and connector is -20°C to +105°C.
- Start time to data ready is the time to get valid data after POR (Power on Reset). The time to get subsequent valid data is then specified by the response time specification.
- 10. Sharp edge strongly recommended for welding applications. Optimum weld parameters will reduce the effect of weld heat on sensor performance. Devices with lower pressure ranges have greater susceptibility to heat generated during the weld process
- 11. Device marking:
 - Each part shall be identified with model number, pressure range, type ('A' for absolute or 'g' for gage), Lot number, serial number, and data code.
- 12. Shipping/Packaging Requirements: each device will be shipped individually packaged in a plastic vial with anti-static foam. For devices without fittings, the stainless steel diaphragm is protected by a static dissipative cap.
- 13. Direct mechanical contact with Diaphragm is prohibited. Diaphragm surface must remain free of defects (scratches, punctures, dents, fingerprints, etc) for device to operate properly. Caution is advised when handling parts with exposed diaphragms. Use protective cap whenever devices are not in use



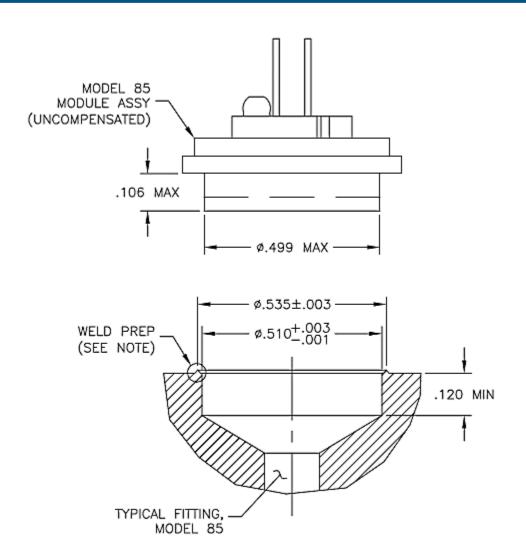
DIMENSIONS





PAD/CNDTR	FUNCTION
1	VDD
2	GND
3	SCL/SCLK
4	SDA/MISO
5	INT/SS



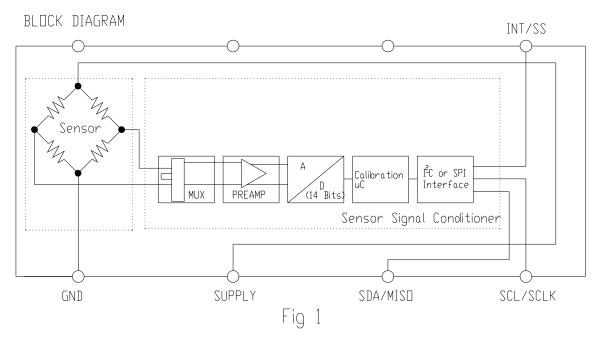


NOTE: WELD PREP SHOWN IS FOR RESISTANCE WELD. ACTUAL GEOMETERY VARIES PER CUSTOMER REQUIREMENTS.

TABLE 1: FITTING DIMENSIONS					
FITTING TYPE	"A" DIM	"B" DIM	"C" DIM		
4	1/4-18 NPT	.93[23.6]	5/8[15.9] HEX		
5	1/4-19 BSP	.96[24.4]	3/4[19.0] HEX		
8	1/8-27 NPT	.80[20.3]	5/8[15.9] HEX		
0 w/o FITTING					
ALL DIMS ARE FOR REFERENCE					



BLOCK DIAGRAM



I2C INTERFACE PARAMETERS

PARAMETERS	SYMBOL	MIN	TYP	MAX	UNITS
SCLK CLOCK FREQUENCY	FSCL	100		400	KHz
START CONDITION HOLD TIME RELATIVE TO SCL EDGE	tHDSTA	0.1			uS
MINIMUM SCL CLOCK LOW WIDTH @1	tL□W	0.6			uS
MINIMUM SCL CLOCK HIGH WIDTH @1	tHIGH	0.6			uS
START CONDITION SETUP TIME RELATIVE TO SCL EDGE	tSUSTA	0.1			uS
DATA HOLD TIME ON SDA RELATIVE TO SCL EDGE	tHDDAT	0			uS
DATA SETUP TIME ON SDA RELATIVE TO SCL EDGE	tSUDAT	0.1			uS
STOP CONDITION SETUP TIME ON SCL	tSUSTO	0.1			uS
BUS FREE TIME BETWEEN STOP AND START CONDITION	tBUS	2			uS

SPI INTERFACE PARAMETERS

PARAMETERS	SYMBOL	MIN	TYP	MAX	UNITS
SCLK CLOCK FREQUENCY	FSCL	50		800	KHz
SS DROP TO FIRST CLOCK EDGE	tHDSS	2.5			uS
MINIMUM SCL CLOCK LOW WIDTH @1	tL□W	0.6			uS
MINIMUM SCL CLOCK HIGH WIDTH @1	tHIGH	0.6			uS
CLOCK EDGE TO DATA TRANSITION	tCLKD	0		0.1	uS
RISE OF SS RELATIVE TO LAST CLOCK EDGE	tSUSS	0.1			uS
BUS FREE TIME BETWEEN RISE AND FALL OF SS	tBUS	2			uS

@1 COMBINED LOW AND HIGH WIDTHS MUST EQUAL OR EXCEED MINIMUM SCL PERIOD.



TEMPERATURE ACCURACY / TOTAL ERROR BAND

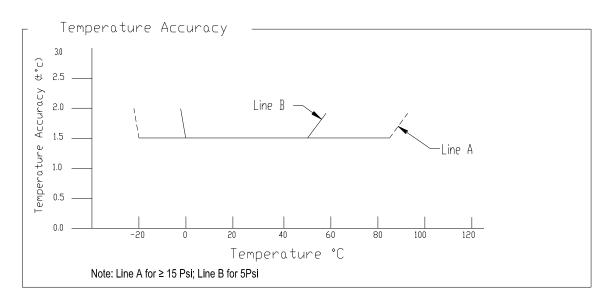


Fig 2

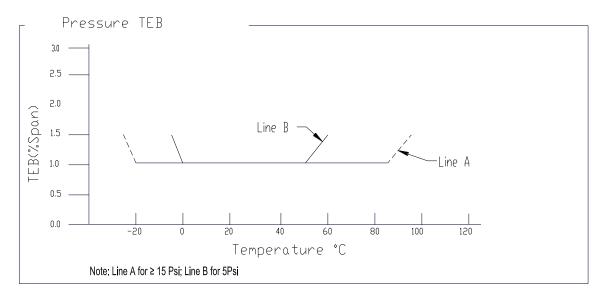


Fig 3



PRESSURE TRANSFER FUNCTIONS

Pressure Transfer Functions

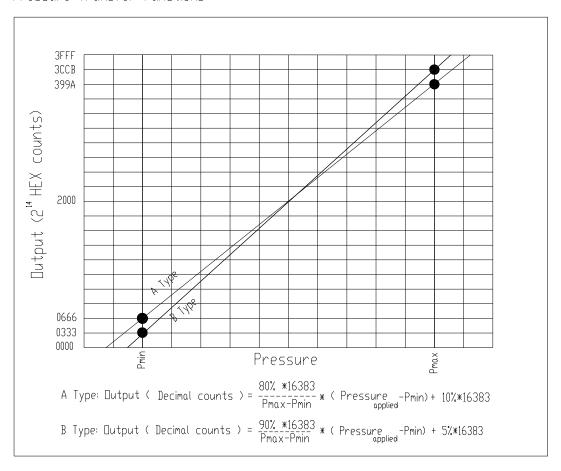


Fig 4

Sensor Dutput at Significant Percentages

% Output	Digital Counts (decimal)	Digital Counts (hex)
0	0	0 X 0000
5	819	0 X 0333
10	1638	0 X 0666
50	8192	0 X 2000
90	14746	0 X 399A
95	15563	O X 3CCB
100	16383	0 X 3FFF



TEMPERATURE TRANSFER FUNCTIONS

Temperature Transfer Functions

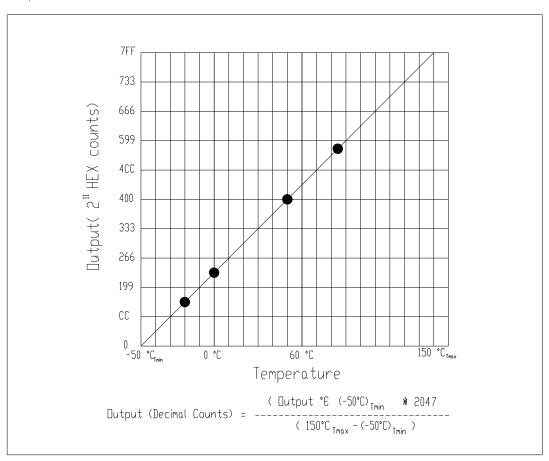


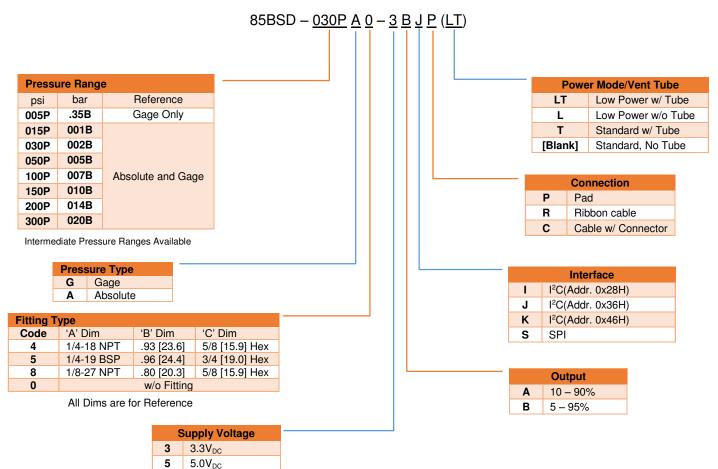
Fig 5

Temperature Dutput vs Counts

□utput °C	Digital Counts (decimal)	Digital Counts (hex)
-50	0	0 X 0000
-20	307	0 X 0133
0	512	0 X 0200
25	767	0 X 02FF
50	1024	0 X 0400
85	1381	0 X 0565
150	2047	0 X 07FF



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